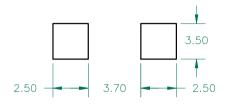
MGV0602R22M-10

PHYSICAL DIMENSIONS:

Α	7.30	±	0.50
В	6.70	\pm	0.30
С	2.00	±	0.30
D	2.90	±	0.30
F	1.60	<u>+</u>	0.50

LAND PATTERNS FOR REFLOW SOLDERING

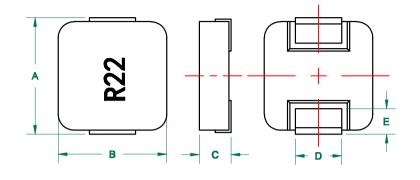




ELECTRICAL SPECIFICATION @ 25°C

	Min	Nom	Max
INDUCTANCE (uH) L @ 100 KHz/0.25V ± 20%	0.176	0.220	0.264
DCR (Ω)			0.0057

Saturation Current ³ Isat (A)	26.00
Temperature Rise Current Irms ⁴ (A)	14.00









NOTES: UNLESS OTHERWISE SPECIFIED

- 1.COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 2.OPERATION TEMPERATURE RANGE:
 - -40°C~+125°C (INCLUDING SELF-HEATING).
- 3.SATURATION CURRENT Isat IS DEFINED AS MAXIMUM AMOUNT OF CURRENT BY WHICH INDUCTANCE WILL DROP BY TYPICAL VALUE OF 25% OF INITIAL INDUCTANCE (Ta=25±5°C).
- 4.TEMPERATURE RISE CURRENT (Irms): DC CURRENT THAT CAUSES THE TEMPERATURE RISE ($\Delta T \leq 40^{\circ}$ C) FROM 25°C AMBIENT.

DIMENSIONS ARE IN mm. This			This print is the property of Laird	П						
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				MGV0602R22M-10	A		WER JCTOR	QIU		
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				DATE: 02/19/13 SC	SCALE: NTS SHEET:					
Α	ORIGINAL DRAFT	02/19/13	QIU		OOL #		1 4			
REV	DESCRIPTION	DATE	INT	MGV0602R22M-10-A		-		of 1		